

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Yeeheng Lee</td> <td>10/13/2009</td> </tr> <tr> <td>Sung-Shan Tai</td> <td>10/12/2009</td> </tr> <tr> <td>Hong Chang</td> <td>10/12/2009</td> </tr> <tr> <td>John Chen</td> <td>10/14/2009</td> </tr> </tbody> </table>		Name	Execution Date	Yeeheng Lee	10/13/2009	Sung-Shan Tai	10/12/2009	Hong Chang	10/12/2009	John Chen	10/14/2009
Name	Execution Date										
Yeeheng Lee	10/13/2009										
Sung-Shan Tai	10/12/2009										
Hong Chang	10/12/2009										
John Chen	10/14/2009										
RECEIVING PARTY DATA											
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>ALPHA & OMEGA SEMICONDUCTOR INCORPORATED</td> </tr> <tr> <td>Street Address:</td> <td>495 Mercury Drive</td> </tr> <tr> <td>City:</td> <td>Sunnyvale</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>94085</td> </tr> </table>		Name:	ALPHA & OMEGA SEMICONDUCTOR INCORPORATED	Street Address:	495 Mercury Drive	City:	Sunnyvale	State/Country:	CALIFORNIA	Postal Code:	94085
Name:	ALPHA & OMEGA SEMICONDUCTOR INCORPORATED										
Street Address:	495 Mercury Drive										
City:	Sunnyvale										
State/Country:	CALIFORNIA										
Postal Code:	94085										
PROPERTY NUMBERS Total: 1											
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12551417</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12551417						
Property Type	Number										
Application Number:	12551417										
CORRESPONDENCE DATA											
<p>Fax Number: (510)668-0239</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 510-668-0965</p> <p>Email: contact@jdipatent.com</p> <p>Correspondent Name: Joshua D. Isenberg</p> <p>Address Line 1: 809 Corporate Way</p> <p>Address Line 4: Fremont, CALIFORNIA 94539</p>											
ATTORNEY DOCKET NUMBER:	ANO-023/US										
NAME OF SUBMITTER:	JOSHUA D. ISENBERG										
<p>Total Attachments: 4</p> <p>source=ANO-023US_assignment#page1.tif</p>											

OP \$40.00 12551417

501000643

PATENT
REEL: 023439 FRAME: 0282

source=ANO-023US_assignment#page2.tif
source=ANO-023US_assignment#page3.tif
source=ANO-023US_assignment#page4.tif

ASSIGNMENT

**INVENTOR
AND CITY**

Whereas, I, **Yeeheng Lee** of 1436 Bellemeade St.
San Jose, CA 95131

have invented:

TITLE:

**FABRICATION OF TRENCH DMOS DEVICE HAVING THICK
BOTTOM SHIELDING OXIDE**

and executed a United States patent application number **12/551,417** filed
August 31, 2009 therefor on:

**DATE INVENTOR
SIGNED THE
DECLARATION**

Oct. 13th, 2009.

Whereas, **Alpha & Omega Semiconductor Incorporated**, a
California Corporation, having its registered address at 495 Mercury
Drive, Sunnyvale, CA 94085, (hereinafter called **AOS**), desires to acquire
the entire right, title and interest of said application and invention, and to
any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is
hereby acknowledged, I, the above named, hereby sell, assign, and transfer
to **AOS**, its successors and assigns, the entire right, title and interest in the
said application and invention therein disclosed for the United States and
foreign countries, and all rights of priority resulting from the filing said
United States application, and I request the Commissioner of Patents to
issue any Letters Patent granted upon the invention set forth in said
application to **AOS** its successors and assigns; and I hereby agree that
AOS may apply for foreign Letters Patent on said invention and I will
execute all papers necessary in connection with the United States and
foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sunnyvale

DATE

on Oct. 13th, 2009

Lee Yf 10/13/09
SIGNATURE OF INVENTOR

ASSIGNMENT

**INVENTOR
AND CITY**

Whereas, I, **Sung-Shan Tai** of 1256 Lockhaven Way
San Jose, CA 95129

have invented:

TITLE:

**FABRICATION OF TRENCH DMOS DEVICE HAVING THICK
BOTTOM SHIELDING OXIDE**

and executed a United States patent application number **12/551,417** filed
August 31, 2009 therefor on:

**DATE INVENTOR
SIGNED THE
DECLARATION**

Oct - 12, 2009.

Whereas, **Alpha & Omega Semiconductor Incorporated**, a
California Corporation, having its registered address at 495 Mercury
Drive, Sunnyvale, CA 94085, (hereinafter called **AOS**), desires to acquire
the entire right, title and interest of said application and invention, and to
any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is
hereby acknowledged, I, the above named, hereby sell, assign, and transfer
to **AOS**, its successors and assigns, the entire right, title and interest in the
said application and invention therein disclosed for the United States and
foreign countries, and all rights of priority resulting from the filing said
United States application, and I request the Commissioner of Patents to
issue any Letters Patent granted upon the invention set forth in said
application to **AOS** its successors and assigns; and I hereby agree that
AOS may apply for foreign Letters Patent on said invention and I will
execute all papers necessary in connection with the United States and
foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sunnyvale, CA

DATE

on Oct - 12, 2009


SIGNATURE OF INVENTOR

ASSIGNMENT

**INVENTOR
AND CITY**

Whereas, I, **Hong Chang** of 19561 Scotland Drive
Saratoga, CA 95070

have invented:

TITLE:

**FABRICATION OF TRENCH DMOS DEVICE HAVING THICK
BOTTOM SHIELDING OXIDE**

and executed a United States patent application number **12/551,417** filed
August 31, 2009 therefor on:

**DATE INVENTOR
SIGNED THE
DECLARATION**

10/12, 2009.

Whereas, **Alpha & Omega Semiconductor Incorporated**, a
California Corporation, having its registered address at 495 Mercury
Drive, Sunnyvale, CA 94085, (hereinafter called **AOS**), desires to acquire
the entire right, title and interest of said application and invention, and to
any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is
hereby acknowledged, I, the above named, hereby sell, assign, and transfer
to **AOS**, its successors and assigns, the entire right, title and interest in the
said application and invention therein disclosed for the United States and
foreign countries, and all rights of priority resulting from the filing said
United States application, and I request the Commissioner of Patents to
issue any Letters Patent granted upon the invention set forth in said
application to **AOS** its successors and assigns; and I hereby agree that
AOS may apply for foreign Letters Patent on said invention and I will
execute all papers necessary in connection with the United States and
foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sunnyvale, CA

DATE

on 10/12, 2009


SIGNATURE OF INVENTOR

ASSIGNMENT

**INVENTOR
AND CITY**

Whereas, I, **John Chen** of **2210 Old Page Mill Road**
Palo Alto, CA 94304

have invented:

TITLE:

**FABRICATION OF TRENCH DMOS DEVICE HAVING THICK
BOTTOM SHIELDING OXIDE**

and executed a United States patent application number **12/551,417** filed
August 31, 2009 therefor on:

**DATE INVENTOR
SIGNED THE
DECLARATION**

14th Oct, 2009.

Whereas, **Alpha & Omega Semiconductor Incorporated**, a
California Corporation, having its registered address at **495 Mercury**
Drive, Sunnyvale, CA 94085, (hereinafter called **AOS**), desires to acquire
the entire right, title and interest of said application and invention, and to
any United States and foreign patents to be obtained therefore;

Now therefore for a valuable consideration, receipt whereof is
hereby acknowledged, I, the above named, hereby sell, assign, and transfer
to **AOS**, its successors and assigns, the entire right, title and interest in the
said application and invention therein disclosed for the United States and
foreign countries, and all rights of priority resulting from the filing said
United States application, and I request the Commissioner of Patents to
issue any Letters Patent granted upon the invention set forth in said
application to **AOS** its successors and assigns; and I hereby agree that
AOS may apply for foreign Letters Patent on said invention and I will
execute all papers necessary in connection with the United States and
foreign applications when called upon to do so by

CITY AND

Signed and Sealed at Sunnyvale

DATE

on 14th Oct, 2009


SIGNATURE OF INVENTOR